

Material Logic
DARPA-BAA-10-64
Frequently Asked Questions

Question 1) I was wondering if you would have some time next week to discuss that topic and some concepts we have been formulating.

Answer 1) Unfortunately, because of the aggressive timetable on the Material Logic effort, I do not have the time to meet with people individually to review their concepts, though I will be reviewing and answering questions sent to the BAA mailbox: DARPA-BAA-10-64@darpa.mil.

Question 2) I have noticed that there was a pre-solicitation meeting for the Structural Logic topic and was wondering if we missed out on any specifics of the proposed program that we need to know.

Answer 2) There is no plan to have a proposer's day for Material logic. All the information that was presented at the Structural Logic proposer's day is available online at the DARPA Website. While the two solicitations are similar and you may find it helpful to review the information available on structural logic, please understand that the offering, requirements and scope of the two BAAs are different and proposals will be evaluated independently.

Question 3) Can let us know whether this concept fit with the scope of your program, we would appreciate it very much. Your suggestions and comments are highly welcome.

Answer 3) Unfortunately, because of the aggressive timetable for the Material Logic effort there will not be an opportunity for white paper review, but I would encourage all potential offers with relevant technologies to apply.

Question 4) We have developed a unique material composite I would like to send a proposal for Material Logic if you think this material would be a fit for grant.

Answer 4) Unfortunately, because of the aggressive timetable for the Material Logic effort there will not be an opportunity for white paper review, but I would encourage all potential offers with relevant technologies to apply.